- Programmable Look-Ahead Up/Down Binary Counters
- Fully Synchronous Operation for Counting and Programming
- Internal Look-Ahead for Fast Counting
- Carry Output for n-Bit Cascading
- Fully Independent Clock Circuit

description

These synchronous presettable counters feature an internal carry look-ahead for cascading in high speed counting applications. The 'LS169B and 'S169 are 4-bit binary counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the countenable inputs and internal gating. This mode of operation helps eliminate the output counting spikes that are normally associated with asynchronous (ripple-clock) counters. A buffered clock input triggers the four master-slave flip-flops on the rising (positive-going) edge of the clock waveform.

These counters are fully programmable; that is the outputs may each be preset to either level. The load input circuitry allows loading with the carry-enable output of cascaded counters. As loading is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with the data inputs after the next clock pulse.

SN54LS169B, SN54S169 . . . J OR W PACKAGE SN74LS169B, SN74S169 . . . D OR N PACKAGE (TOP VIEW)

U/D 1 16 VCC
CLK 2 15 RCO
A 3 14 QA
B 4 13 QB
C 5 12 QC

D [] €

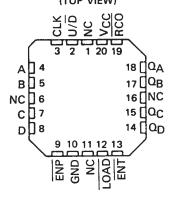
ENP 7

GND ∐8

SN54LS169B, SN54S169 . . . FK PACKAGE (TOP VIEW)

11 Ω_D 10 ENT

9 LOAD



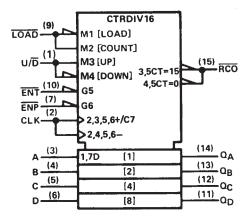
NC-No internal connection

TYPE	''''	TYPICAL MAXIMUM CLOCK FREQUENCY				
	COUNTING					
'LS169B	35MHz	35MHz	100mW			
'S169	70MHz	55MHz	500mW			

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are two count-enable inputs and a carry output. Both count enable inputs (ENP, ENT) must be low to count. The direction of the count is determined by the level of the up/down input. When the input is high, the counter counts up; when low, it counts down. Input ENT is fed forward to enable the carry output. The carry output thus enabled will produce a low-level output pulse with a duration approximately equal to the high portion of the QA output when counting up and approximately equal to the low portion of the QA output when counting down. This low-level overflow carry pulse can be used to enable successive cascaded stages. Transitions at the ENP or ENT inputs are allowed regardless of the level of the clock input. All inputs are diode-clamped to minimize transmission-line effects, thereby simplifying system design.

These counters feature a fully independent clock circuit. Changes at control inputs ($\overline{\text{ENP}}$, $\overline{\text{ENT}}$, $\overline{\text{LOAD}}$, $\overline{\text{U/D}}$) that will modify the operating mode have no effect until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) will be dictated solely by the conditions meeting the stable setup and hold times.

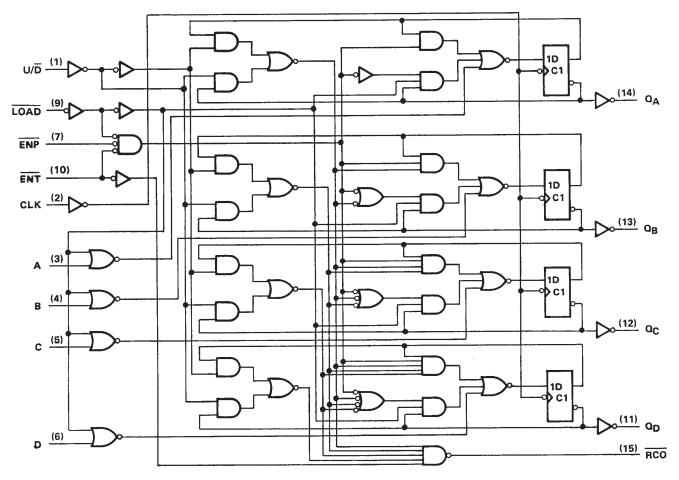
logic symbol[†]



 † This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

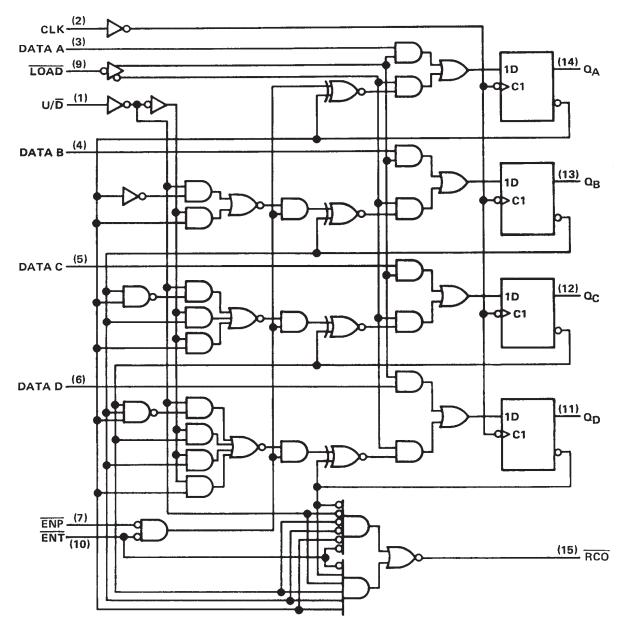


logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

logic diagram (positive logic)



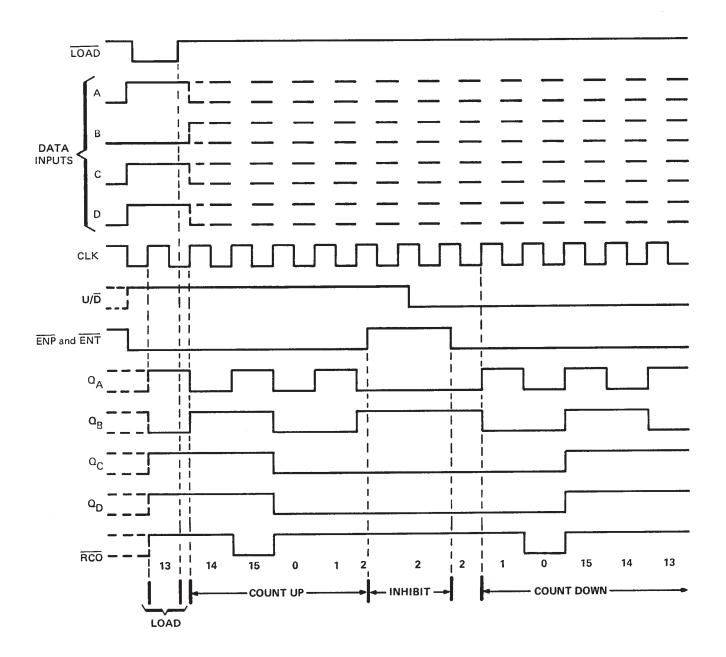
Pin numbers shown are for D, J, N, and W packages.



typical load, count, and inhibit sequences

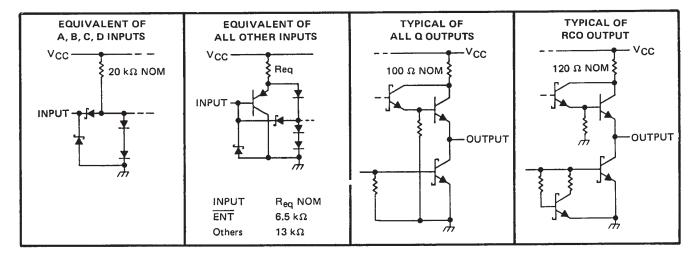
Illustrated below is the following sequence:

- 1. Load (preset) to binary thirteen.
- 2. Count up to fourteen, fifteen (maximum), zero, one, and two.
- 3. Inhibit
- 4. Count down to one, zero (minimum), fifteen, fourteen, and thirteen





schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		7 V
Input voltage		7 V
Operating free-air temperature range	: SN54LS169B	$ 55^{\circ}$ C to 125° C
	SN74LS169B	0°C to 70°C
Storage temperature range		65° C to 150° C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

				SI	154LS1	69B	SN74LS169B			UNIT
				MIN	NOM	MAX	MIN	NOM	MAX	ONT
Vcc	Supply voltage			4.5	5	5.5	4.75	5	5.25	V
ViH	High-level-input voltage			2			2			V
VIL	Low-level input voltage					0.7			0.8	V
ЮН	High-level output current		RCO			- 0.4			- 0.4	mA
OH Might total content			Any Q			- 1.2			- 1.2	mA
OL Low-level output current		RCO			4			8	mA	
		Any Q			12			24	mA	
fclock	Clock frequency		1	0		20	0		20	MHz
tw(clock)	Width of clock pulse (high or low)	(see Figure 1)		25			25			ns
		Data inputs	A, B, C, D	30			30]
		ENP or EN	ī	30			30			ns
t _{su}	su Setup time, (see Figure 1)	Load		35			35] '''
	U/D	U/D				35				
th	Hold time at any input with respe	ct to clock (see Fig	ure 1)	0			0			ns
TA	Operating free-air temperature			- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					SN	154LS16	9B	SN	174LS16	59B	UNIT	
PARAMETER		TEST COND	ITIONS		MIN	TYP‡	MAX	MIN	TYP‡	MAX	ONT	
VIK	V _{CC} = MIN,	I ₁ = - 18 mA					– 1.5			– 1. 5	V	
	V _{CC} = MIN,	V _{IH} = 2 V,	RCO	l _{OH} = - 0.4 mA	2.5	3.4		2.7	3.4		V	
Vон	VIL = MAX		Any Q	I _{OH} = - 1.2 mA	2.4	3.2		2.4	3.2] <u> </u>	
				I _{OH} = 4 mA		0.25	0.4		0.25	0.4		
	V _{CC} = MIN,	V _{IH} = 2 V,	Any Q	IOL = 8 mA					0.35	0.5] _/	
VOL	VIL = MAX					I _{OL} = 12 mA		0.25	0.4		0.25	0.4
				I _{OL} = 24 mA					0.35	0.5]	
l ₁	V _{CC} = MAX,	V _I = 7 V					0.1			0.1	mΑ	
IJH	V _{CC} = MAX,	V ₁ = 2.7 V	······································				20			20	μΑ	
	., .,,,		U/D, LC	AD, ENP, CLK			- 0.2			- 0.2	m.A	
IL	V _{CC} = MAX,	V ₁ = 0.4 V	All othe	r inputs			- 0.4			- 0.4] ""	
			RCO		- 20		- 100	- 20		- 100		
losş	V _{CC} = MAX,	VO = 0 V	Any Q		- 30		- 130	- 30		- 130	m/	
lcc	V _{CC} = MAX,	See Note 2				28	45		28	45	m/	

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

	FROM	ROM TO		TEST CONDITIONS				UNIT
PARAMETER¶	(INPUT)	(OUTPUT)	TEST CON	TEST CONDITIONS		TYP	MAX	UNII
fmax					20	35		MHz
^t PLH	01.14	RCO				26	40	ns
tPHL tPHL	CLK	HCO HCO				17	25	115
^t PLH	ENT	RCO		045 -5		15	25	ns
tPHL	ENI	HCO	$R_L = 2 k\Omega$,	$R_L = 2 k\Omega$, $C_L = 15 pF$		11	20	'''
^t PLH		700				23	35	ns
^t PHL	U/Ω	RCO				15	25	""
^t PLH						16	25	
tPHL	CLK	Any Q	R _L = 667 Ω,	C _L = 45 pF		17	25	ns

[¶] Propagation delay time from up/down to ripple carry must be measured with the counter at either a minimum or a maximum count. As the logic level of the up/down input is changed, the ripple carry output will follow. If the count is minimum (0), the ripple carry output transistion will be in phase. If the count is maximum (15), the ripple carry output will be out of phase.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡]All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25 ^{\circ} \text{C}$.

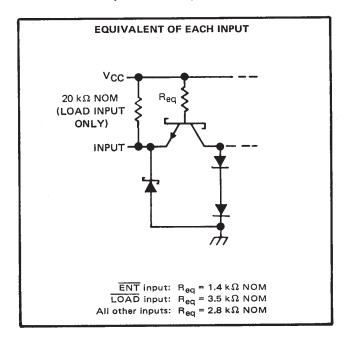
[§] Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

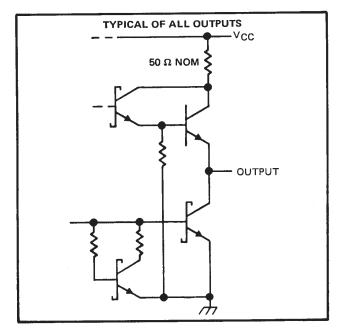
NOTE 2: I_{CC} is measured after applying a momentary 4.5 V, then ground, to the clock input with all other inputs grounded and the outputs open.

SYNCHRONOUS 4-BIT UP/DOWN BINARY COUNTERS

SDLS134 - OCTOBER 1976 - REVISED MARCH 1988

schematics of inputs and outputs





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (See Note 4)	
Input voltage	5.5 V
Interemitter voltage (see Note 5)	
Operating free-air temperature range: SN54S169 (see Not	e 6)
	0°C to 70°C
Storage temperature range	– 65°C to 150°C

recommended operating conditions

		SN54S169		SN74S169			UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH				- 1			- 1	mA
Low-level output current, IQL				20			20	mA
Clock frequency, fclock		0		40	0		40	MHz
Width of clock pulse, tw(clock) (high	or low) (see Figure 1)	10			10			ns
	Data inputs A, B, C, D	4			4			1
·	ENP or ENT	14			14			ns
Setup time,t _{SU} (see Figure 1)	Load	9			6] ""
	U/D	20			20			
Hold time at any input with respect to	clock, t _w (see Figure 1)	1			1			ns
Operating free-air temperature, TA (see Note 6)		- 55		125	0		70	°C

NOTES: 4. Voltage values, except interemitter voltage, are with respect to network ground terminal.

- 5. This is the voltage between two emitters of a multiple-emitter transistor. For these circuits, this rating applies between the count enable inputs $\overline{\text{ENP}}$ and $\overline{\text{ENT}}$.
- 6. A SN54S169 in the W package operating at free-air temperatures above 91 °C requires a heat sink that provides a thermal resistance from case to free-air, $R_{\theta CA}$, of not more than 26 °C/W.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST SOMETIONS!		SN54S169			SN74S169			UNIT
		TEST CO	TEST CONDITIONS†		TYP‡	MAX	MIN	TYP [‡]	MAX	CIVILI
V _{IH} High-level input voltage				2			2			V
V _{IL} Low-level input voltage						0.8			0.8	٧
VIK Input clamp voltage		V _{CC} = MIN,	$I_{J} = -18 \text{ mA}$			-1.2			-1.2	V
V _{OH} High-level output voltage		$V_{CC} = MIN,$ $V_{IL} = 0.8 V,$	$V_{lH} = 2 V$, $I_{OH} = -1 mA$	2.5	3.4		2.7	3.4		٧
V _{OL} Low-level output voltage		$V_{CC} = MIN,$ $V_{IL} = 0.8 V,$	V _{IH} = 2 V, I _{OL} = 20 mA			0.5			0.5	٧
I Input current at maximum inp	ut voltage	V _{CC} = MAX,	V ₁ = 5.5 V			1			1	mA
	ENT					100			100	
I _{IH} High-level input current	Load	V _{CC} = MAX,	$V_i = 2.7 V$	- 10		- 200	10		- 200	μΑ
	Other inputs					50			50	
	ENT		V 05V			- 4			-4	mA
I _{IL} Low-level input current	Other inputs	$V_{CC} = MAX,$	VI = 0.5 V			- 2			-2	1111/
IOS Short-circuit output current§		V _{CC} = MAX,		- 40		- 100	- 40		- 100	mA
ICC Supply current		V _{CC} = MAX,	See Note 2		100	160		100	160	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: ICC is measured after applying a momentary 4.5 V, then ground, to the clock input with all other inputs grounded and the outputs open.

switching characteristics, VCC = 5 V, TA = 25°C

4	FROM	то		U	D - H	IGH	U/	<u>D</u> - LO	wc	UNIT			
PARAMETER¶	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	וואוטן			
f _{max}				40	70		40	55		MHz			
^t PLH	01.14	500			14	21		14	21	ns			
tPHL	CLK	RCO			20	28		20	28	,,,,			
tPLH t	01.16				1 0	$C_L = 15 \mathrm{pF},$ $R_L = 280 \Omega,$		8	15		8	15	ns
tPHL	CLK	Any Q	See Figures 2 and 3		11	15		11	15] '''			
tPLH		===	RCO and Note 3		7.5	11		6	12	ns			
tPHL	ENT	RCO			15	22		15	25] ''3			
tPLH [♦]			1		9	15		8	15				
tpHL♦	Ū/Ū	RCO	RCO		10	15		16	22	ns			

 $¹_{t_{max}} = maximum clock frequency$

Propagation delay time from up/down to ripple carry must be measured with the counter at either a minimum or a maximum count. As the logic level of the up/down input is changed, the ripple carry output will follow. If the count is minimum (0), the ripple carry output transition will be in phase. If the count is maximum (15 for 'S169), the ripple carry output will be out of phase.

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



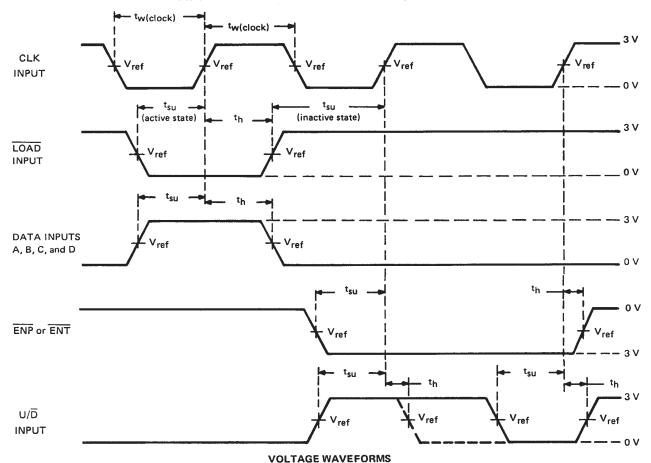
 $^{^{\}ddagger}$ All typical values are at VCC = 5 V, TA = 25 °C.

[§] Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

tpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

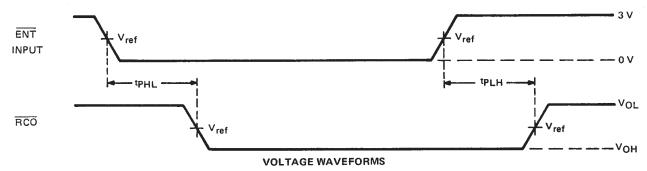
PARAMETER MEASUREMENT INFORMATION



NOTES: A. The input pulses are supplied by a generator having the following characteristics: PRR \leq 1 MHz, duty cycle \leq 50%, $Z_{out} \approx$ 50 Ω ; for 'LS169B, $t_r \leq$ 15 ns; $t_f \leq$ 6 ns, and for 'S169, $t_r \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.

B. For 'LS169B, V_{ref} = 1.3 V; for 'S168 and 'S169, V_{ref} = 1.5 V.

FIGURE 1-PULSE WIDTHS, SETUP TIMES, HOLD TIMES



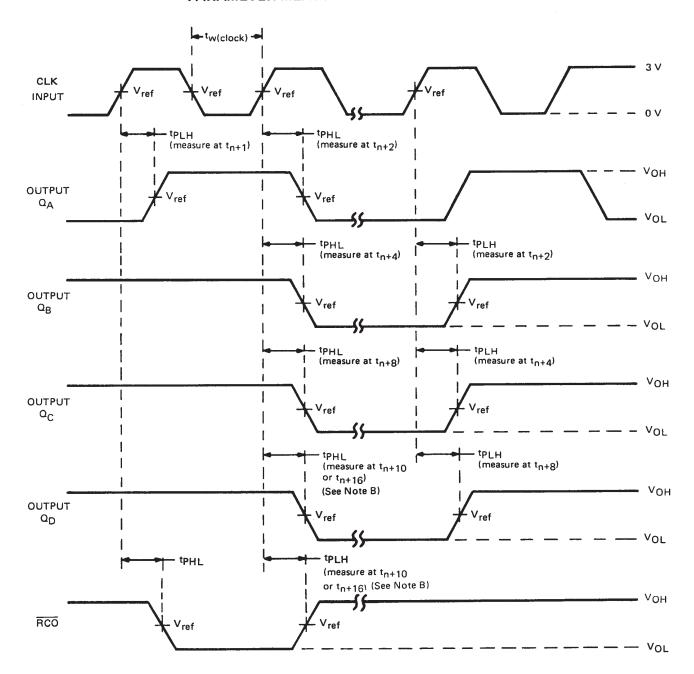
NOTES: A. The input pulses are supplied by a generator having the following characteristics: PRR \leq MHz, duty cycle \leq 50%, Z_{out} \approx 50 Ω ; for 'LS169B, t_r \leq 15 ns, t_f \leq 5 ns; and for 'S169, t_r \leq 2.5 ns.

- B. tpLH and tpHL from enable T input to ripple carry output assume that the counter is at the maximum count, all Q outputs high.
- C. For 'LS169B, $V_{ref} = 1.3 \text{ V}$; for 'S169, $V_{ref} = 1.5 \text{ V}$.
- D. Propagation delay time from up/down to ripple carry must be measured with the counter at either a minimum or a maximum count. As the logic level of the up/down input is changed, the ripple carry output will follow. If the count is minimum (0) the ripple carry output transition will be in phase. If the count is maximum (15), the ripple carry output will be out of phase.

FIGURE 2-PROPAGATION DELAY TIMES TO CARRY OUTPUT



PARAMETER MEASUREMENT INFORMATION



UP-COUNT VOLTAGE WAVEFORMS

NOTES: A. The input pulses are supplied by a generator having the following characteristics: PRR ≤ 1 MHz, duty cycle ≤50%, $Z_{out} \approx 50~\Omega$; for 'LS169B, $t_r \leq 15$ ns; $t_f \leq 6$ ns, and 'S169, $t_r \leq 2.5$ ns, $t_f \leq 2.5$ ns. Vary PRR to measure f_{max} .

- B. Outputs Q_D and carry are tested at t_{n+16} , where t_n is the bit-time when all outputs are low. C. For 'LS169B, $V_{ref}=1.3$ V; for 'S169, $V_{ref}=1.5$ V.

FIGURE 3-PROPAGATION DELAY TIMES FROM CLOCK



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dataconverter.ti.com	Automotive	www.ti.com/automotive
dsp.ti.com	Broadband	www.ti.com/broadband
interface.ti.com	Digital Control	www.ti.com/digitalcontrol
logic.ti.com	Military	www.ti.com/military
power.ti.com	Optical Networking	www.ti.com/opticalnetwork
microcontroller.ti.com	Security	www.ti.com/security
www.ti.com/lpw	Telephony	www.ti.com/telephony
	Video & Imaging	www.ti.com/video
	Wireless	www.ti.com/wireless
	dataconverter.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com	amplifier.ti.com dataconverter.ti.com dsp.ti.com dsp.ti.com interface.ti.com logic.ti.com power.ti.com microcontroller.ti.com www.ti.com/lpw Audio Audio Audio Audio Automotive Broadband Digital Control Military Optical Networking Security Telephony Video & Imaging

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Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

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Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
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Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
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Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
Low Power Wireless	www.ti.com/lpw	Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
80018022A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
8001802EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
8001802EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
8001802FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
8001802FA	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SN54LS169BJ	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS169BJ	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S169J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S169J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SN74LS169BD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BD	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BDE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BDE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BDG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BDG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS169BN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS169BNE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS169BNE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS169BNSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BNSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BNSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BNSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BNSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS169BNSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S169J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74S169J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74S169N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S169N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S169N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S169N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI



PACKAGE OPTION ADDENDUM

9-Oct-2007

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SNJ54LS169BFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS169BFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS169BJ	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS169BJ	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS169BW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54LS169BW	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S169FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S169FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S169J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S169J	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S169W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type
SNJ54S169W	ACTIVE	CFP	W	16	1	TBD	A42	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS169BNSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS169BNSR	SO	NS	16	2000	346.0	346.0	33.0

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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